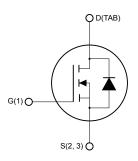


Automotive-grade N-channel 1200 V, 7.25 Ω typ., 1.5 A, MDmesh K5 Power MOSFET in an H²PAK-2 package

Features



H²PAK-2



Order code	V _{DS}	R _{DS(on)} max.	l _D	P _{TOT}
STH2N120K5-2AG	1200 V	10 Ω	1.5 A	60 W

- AEC-Q101 qualified
- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- · Ultra-low gate charge
- 100% avalanche tested

Applications

· Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.



DTG1S23NZ



Product status STH2N120K5-2AG

Product summary ⁽¹⁾			
Order code STH2N120K5-2AG			
Marking	2N120K5		
Package	H ² PAK-2		
Packing	Tape and reel		

 HTRB test was performed at 80% of V_{(BR)DSS} according to AEC-Q101 rev. C. All other tests were performed according to AEC-Q101 rev. D.



1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	±30	V
I_	Drain current (continuous) at T _C = 25 °C	1.5	A
l _D	Drain current (continuous) at T _C = 100 °C	1	
I _{DM} ⁽¹⁾	Drain current (pulsed)	2.5	А
P _{TOT}	Total power dissipation at T _C = 25 °C	60	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	4.5	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature range	-55 to 150	°C
T _J	Operating junction temperature range	-55 to 150	

- 1. Pulse width is limited by safe operating area.
- 2. $I_{SD} \leq 1.5~A$, $di/dt = 100~A/\mu s$, $V_{DS}~(peak) < V_{(BR)DSS}$, $V_{DD} = 80\%~V_{(BR)DSS}$.
- 3. $V_{DS} \le 960 \text{ V}$.

Table 2. Thermal data

:	Symbol	Parameter	Value	Unit
	R _{thj-case}	Thermal resistance junction-case	2.08	°C // //
F	R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	30	°C/W

1. When mounted on an 1-inch² FR-4, 2 Oz copper board.

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR} ⁽¹⁾	Avalanche current, repetitive or not repetitive	0.5	Α
E _{AS} ⁽²⁾	Single pulse avalanche energy	80	mJ

- 1. Pulse width is limited by T_J max.
- 2. Starting $T_J = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V.

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2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0 V, I _D = 1 mA	1200			V
I	Zono moto vielto no due in comunit	V _{GS} = 0 V, V _{DS} = 1200 V			0.5	
IDSS	I _{DSS} Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 1200 V, T _C = 125 °C ⁽¹⁾			100	μA
I _{GSS}	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
V _{GS(th)}	Gate threshold voltage	V _{DS} = V _{GS} , I _D = 100 μA	2	3	4	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 0.5 A		7.25	10	Ω

^{1.} Defined by design, not subject to production test.

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	124	-	
C _{oss}	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	13	-	pF
C _{rss}	Reverse transfer capacitance		-	0.5	-	
C _{o(tr)} ⁽¹⁾	Time-related equivalent capacitance	V _{GS} = 0 V, V _{DS} = 0 to 960 V	-	15	-	pF
C _{o(er)} ⁽²⁾	Energy-related equivalent capacitance	VGS - 0 V, VDS - 0 to 300 V	-	5	-	рі
R _G	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	16	-	Ω
Qg	Total gate charge	V _{DD} = 960 V, I _D = 1.5 A, V _{GS} = 0 to 10 V	-	5.3	-	
Q _{gs}	Gate-source charge	(see Figure 13. Test circuit for gate	-	0.8	-	nC
Q _{gd}	Gate-drain charge	charge behavior)	-	3.5	-	

^{1.} $C_{o(tr)}$ is a constant capacitance value giving the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 600 V, I _D = 0.75 A,	-	10.3	-	
t _r	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	7.8	-	
t _{d(off)}	Turn-off delay time	(see Figure 12. Test circuit for resistive load switching times and	-	34	-	ns
t _f	Fall time	Figure 17. Switching time waveform)	-	39	-	

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^{2.} $C_{o(er)}$ is a constant capacitance value giving the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .



Table 7. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		1.5	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		2.5	Α
V _{SD} ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 1.5 A	-		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 1.5 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	350		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V	-	1.35		μC
I _{RRM}	Reverse recovery current	(see Figure 14. Test circuit for inductive load switching and diode recovery times)	-	7.7		А
t _{rr}	Reverse recovery time	I _{SD} = 1.5 A, di/dt = 100 A/μs,	-	600		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V, T _J = 150 °C	-	2.09		μC
I _{RRM}	Reverse recovery current	(see Figure 14. Test circuit for inductive load switching and diode recovery times)	-	7.7		Α

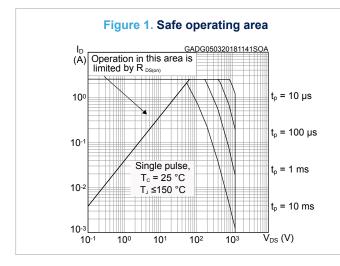
^{1.} Pulse width is limited by safe operating area.

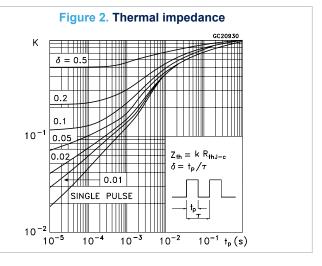
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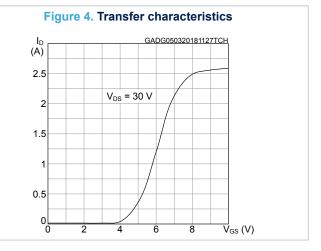
^{2.} Pulse test: pulse duration = 300 μ s, duty cycle 1.5%.

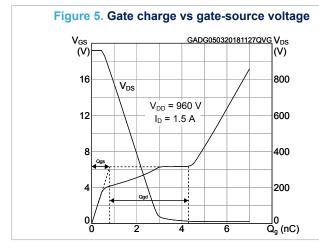


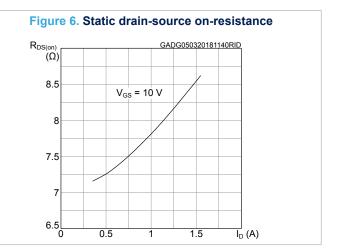
2.1 Electrical characteristics (curves)











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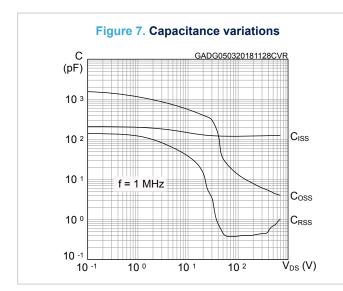
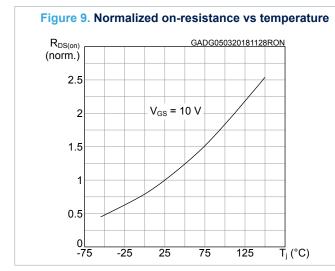
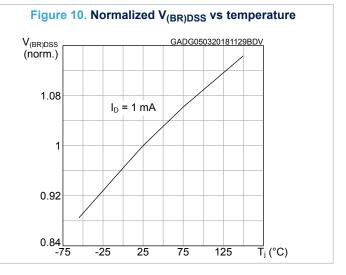
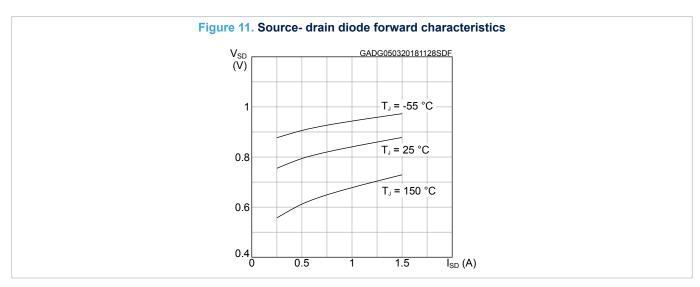


Figure 8. Normalized gate threshold voltage vs temperature $V_{GS(th)}$ (norm.) $I_{D} = 100 \, \mu A$ $I_{D} = 100 \, \mu A$







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3 Test circuits

Figure 12. Test circuit for resistive load switching times

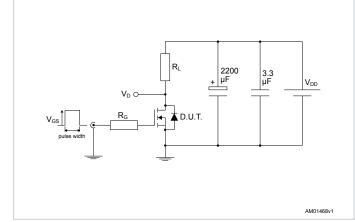


Figure 13. Test circuit for gate charge behavior

VGS

Pulse width

2.7 kΩ

AMD(468+10)

Figure 14. Test circuit for inductive load switching and diode recovery times

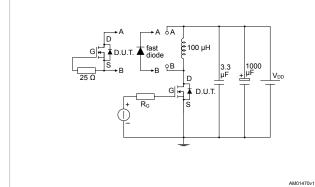


Figure 15. Unclamped inductive load test circuit

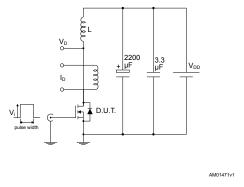


Figure 16. Unclamped inductive waveform

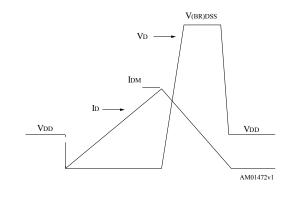
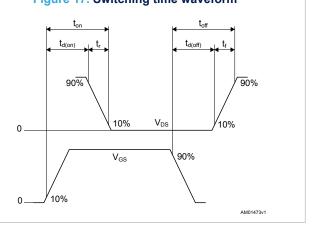


Figure 17. Switching time waveform



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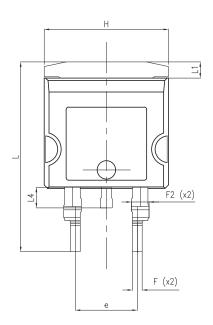


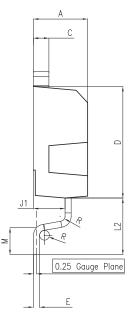
4 Package information

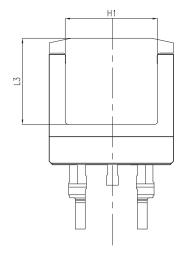
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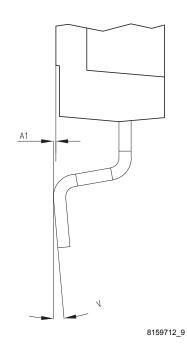
4.1 H²PAK-2 package information

Figure 18. H²PAK-2 package outline









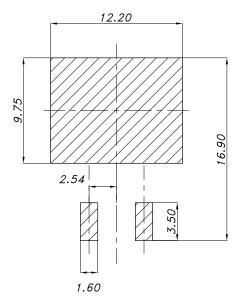
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Table 8. H²PAK-2 package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.30		4.70
A1	0.03		0.20
С	1.17		1.37
D	8.95		9.35
е	4.98		5.18
Е	0.50		0.90
F	0.78		0.85
F2	1.14		1.70
Н	10.00		10.40
H1	7.40	-	7.80
J1	2.49		2.69
L	15.30		15.80
L1	1.27		1.40
L2	4.93		5.23
L3	6.85		7.25
L4	1.50		1.70
M	2.60		2.90
R	0.20		0.60
V	0°		8°

Figure 19. H²PAK-2 recommended footprint



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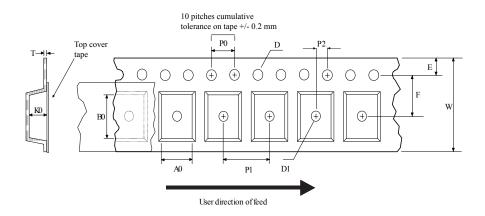
Note: Dimensions are in mm.

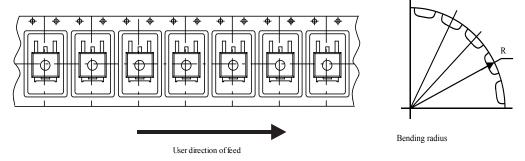
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4.2 Packing information

Figure 20. Tape outline





AM08852v2

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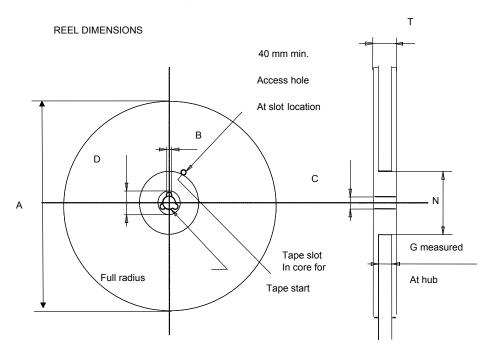


Figure 21. Reel outline

Table 9. Tape and reel mechanical data

	Tape			Reel	
Dim.	r	nm	Dim	m	m
Dilli.	Min.	Max.	Dim.	Min.	Max.
A0	10.5	10.7	Α		330
В0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D	20.2	
Е	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base of	quantity	1000
P2	1.9	2.1	Bulk o	quantity	1000
R	50				•
Т	0.25	0.35			
W	23.7	24.3			

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Revision history

Table 10. Document revision history

Date	Version	Changes
23-Mar-2018	1	Initial release. The document status is preliminary data.
30-Jul-2018	2	The document status was promoted from preliminary to production data. Updated title and features on cover page.
31-Jul-2018	3	Updated the current table. The date for revision 2 was erroneously reported as "19-Jun-2018" instead of "30-Jul-2018".
05-Sep-2018	4	Updated I _{DSS} parameter in <i>Table 4. Static</i> .
16-Jun-2020	5	Updated Section 4 Package information.

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